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(12)

United States Design Patent

Schnell et al.

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(45)

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(54) **EARPHONE**

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(**) Term: **15 Years**

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(51) **LOC (15) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223; D24/174; 128/864–866; 381/380–381
CPC H04R 1/10; H04R 25/00; H04R 25/02; H04R 1/1066; H04R 1/1016; H04R 5/033; H04R 5/0335; H04R 1/1041; H04R 1/105; H04R 1/1091
See application file for complete search history.

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(74) *Attorney, Agent, or Firm* — McAndrews Held & Malloy, Ltd.

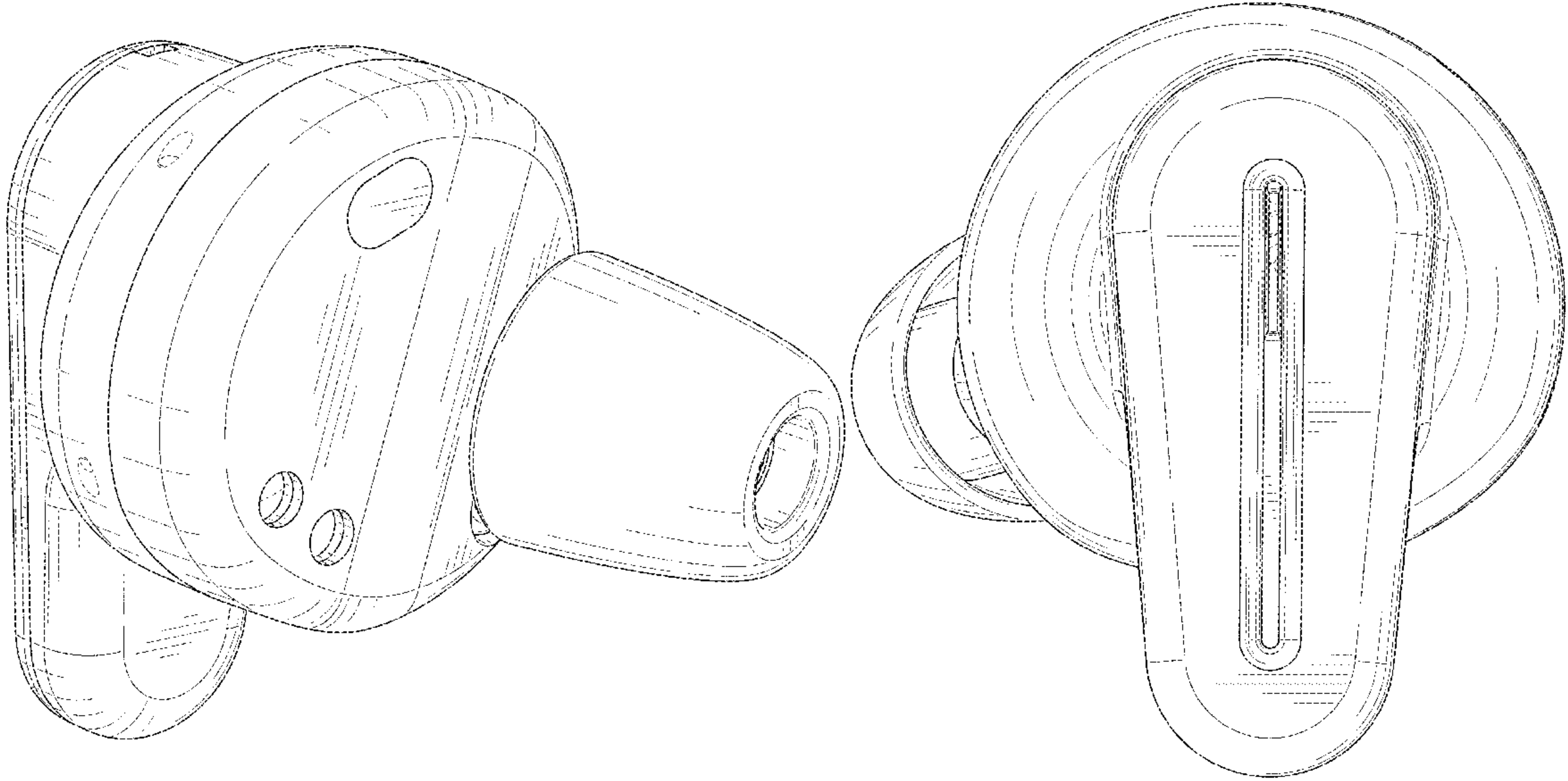
(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a front perspective view of an earphone showing our new design according to a first embodiment; FIG. 2 is a front elevation view thereof; FIG. 3 is a rear elevation view thereof; FIG. 4 is a right side elevation view thereof; FIG. 5 is a left side elevation view thereof; FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; FIG. 8 is a front perspective view of an earphone showing our new design according to a second embodiment; FIG. 9 is a front elevation view thereof; FIG. 10 is a rear elevation view thereof; FIG. 11 is a right side elevation view thereof; FIG. 12 is a left side elevation view thereof; FIG. 13 is a top plan view thereof; and, FIG. 14 is a bottom plan view thereof. The dashed broken lines in the figures illustrate portions of the earphone that form no part of the claimed design.

1 Claim, 14 Drawing Sheets



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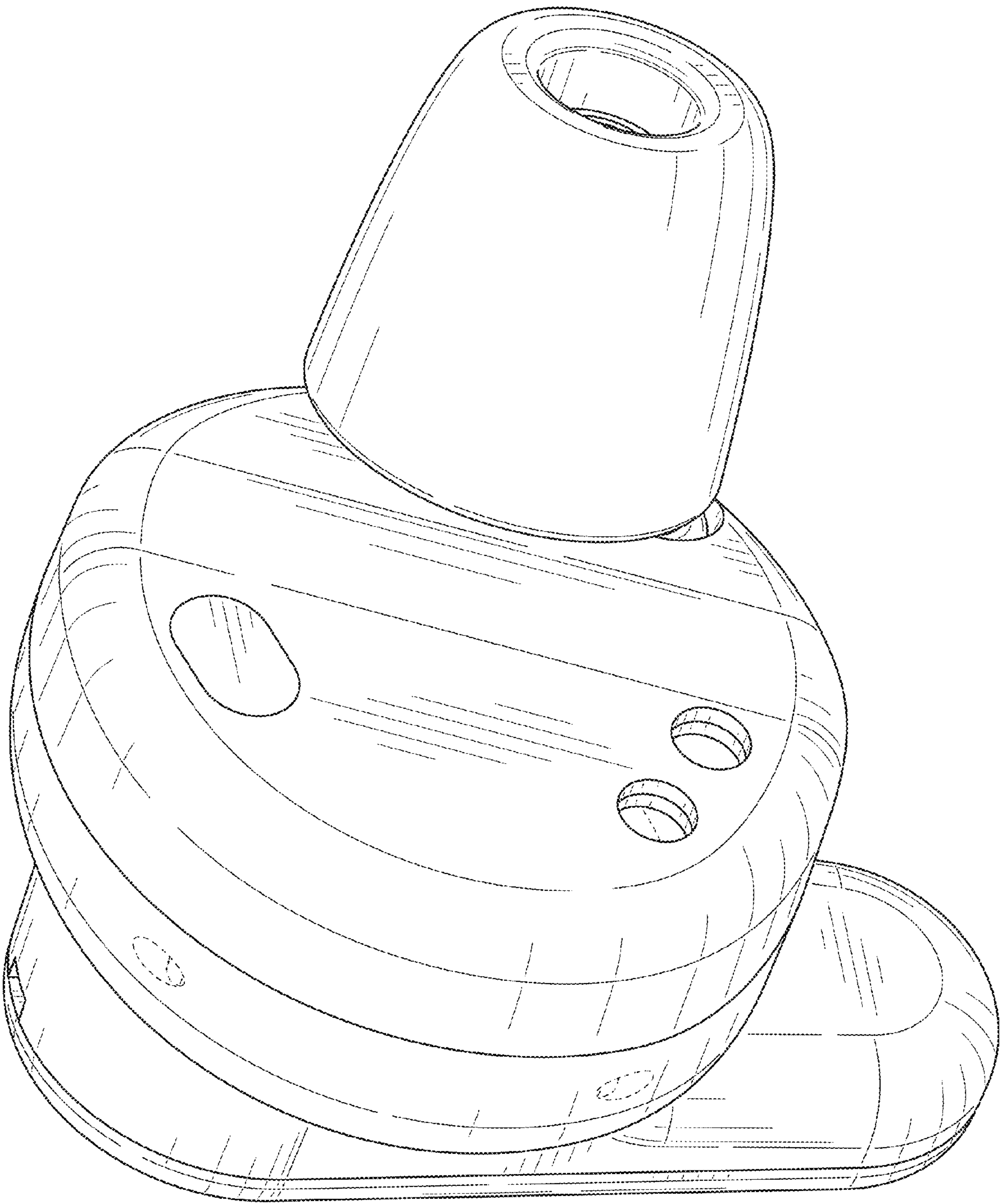


FIG. 1

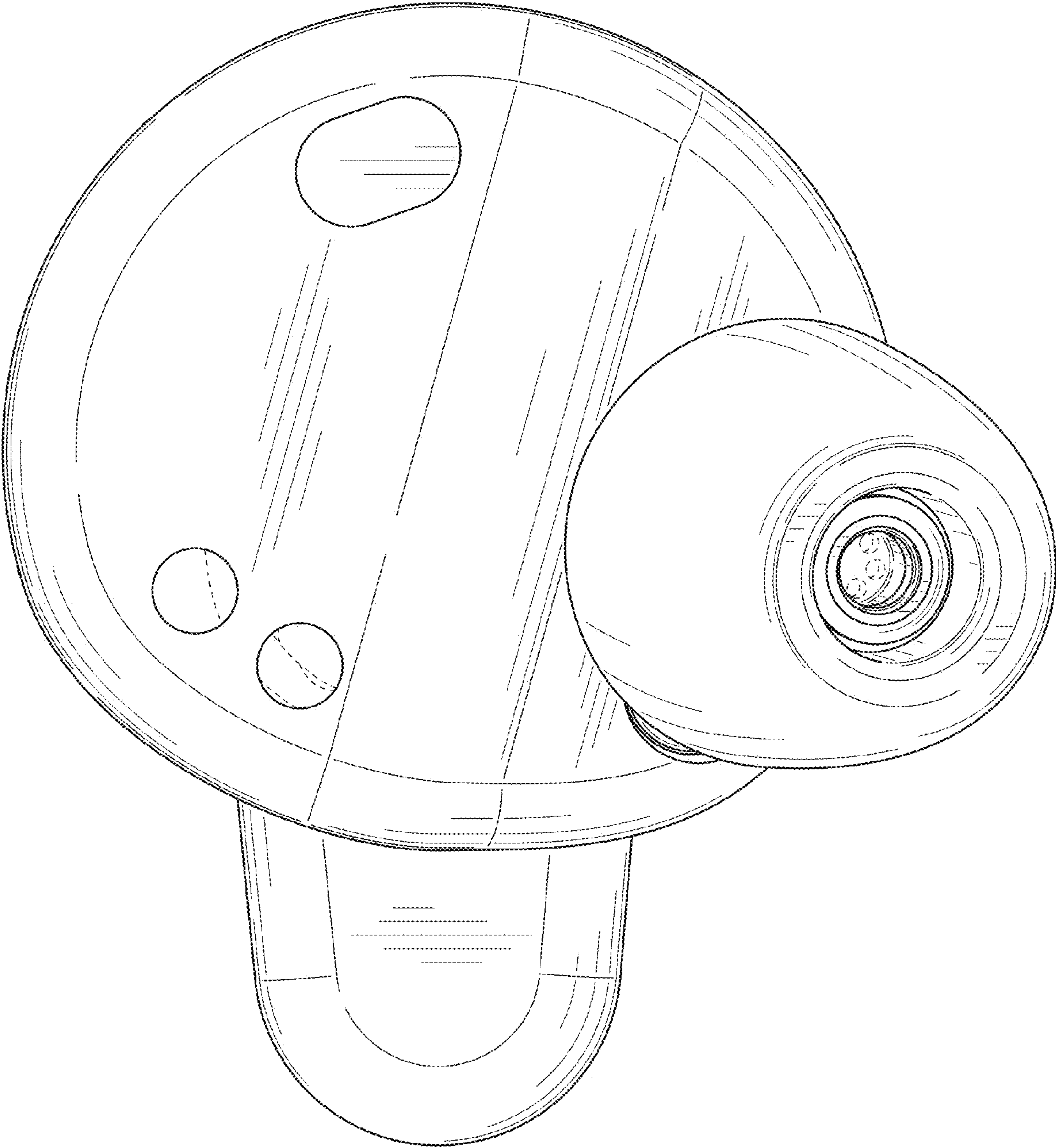


FIG. 2

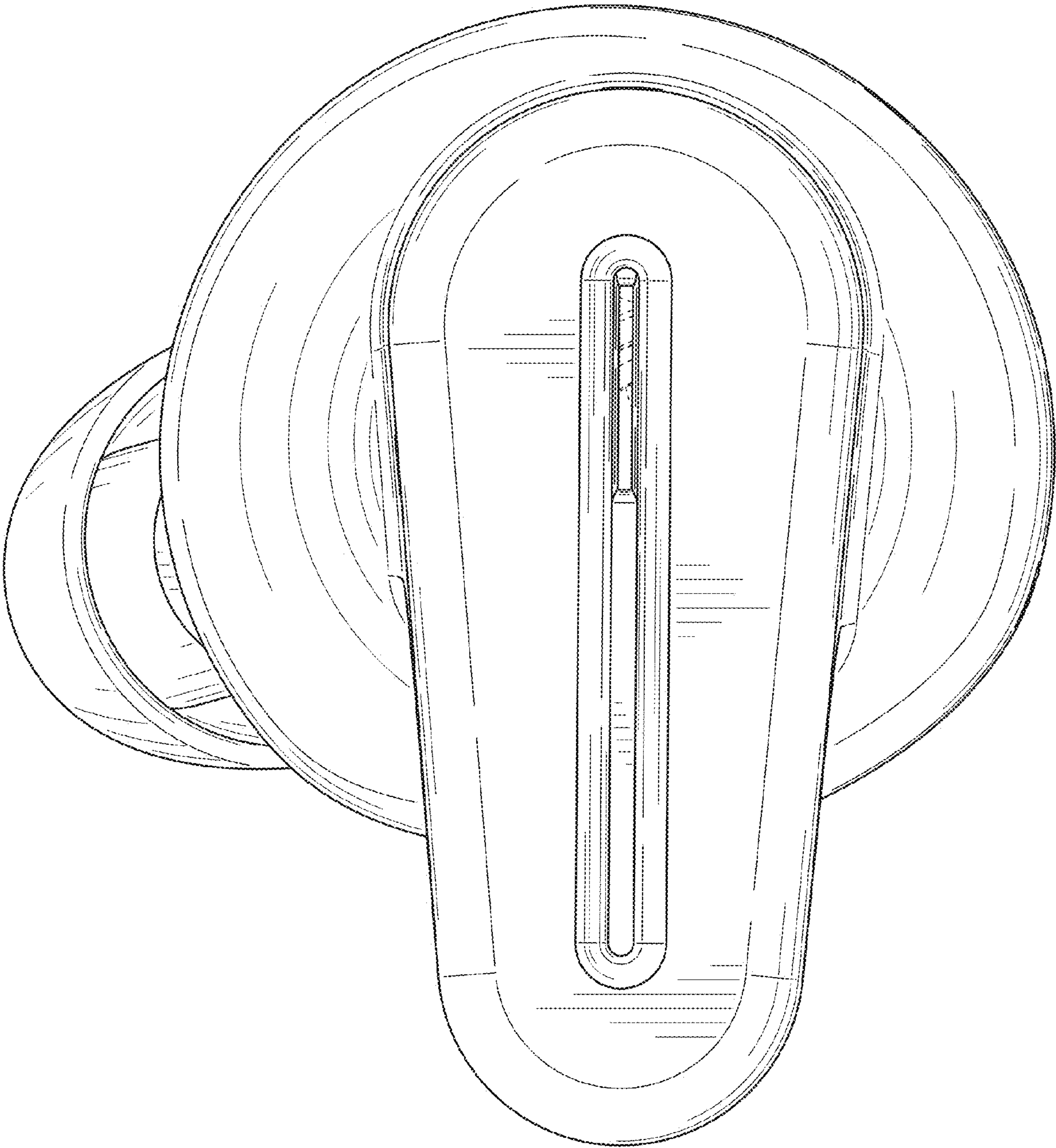


FIG. 3

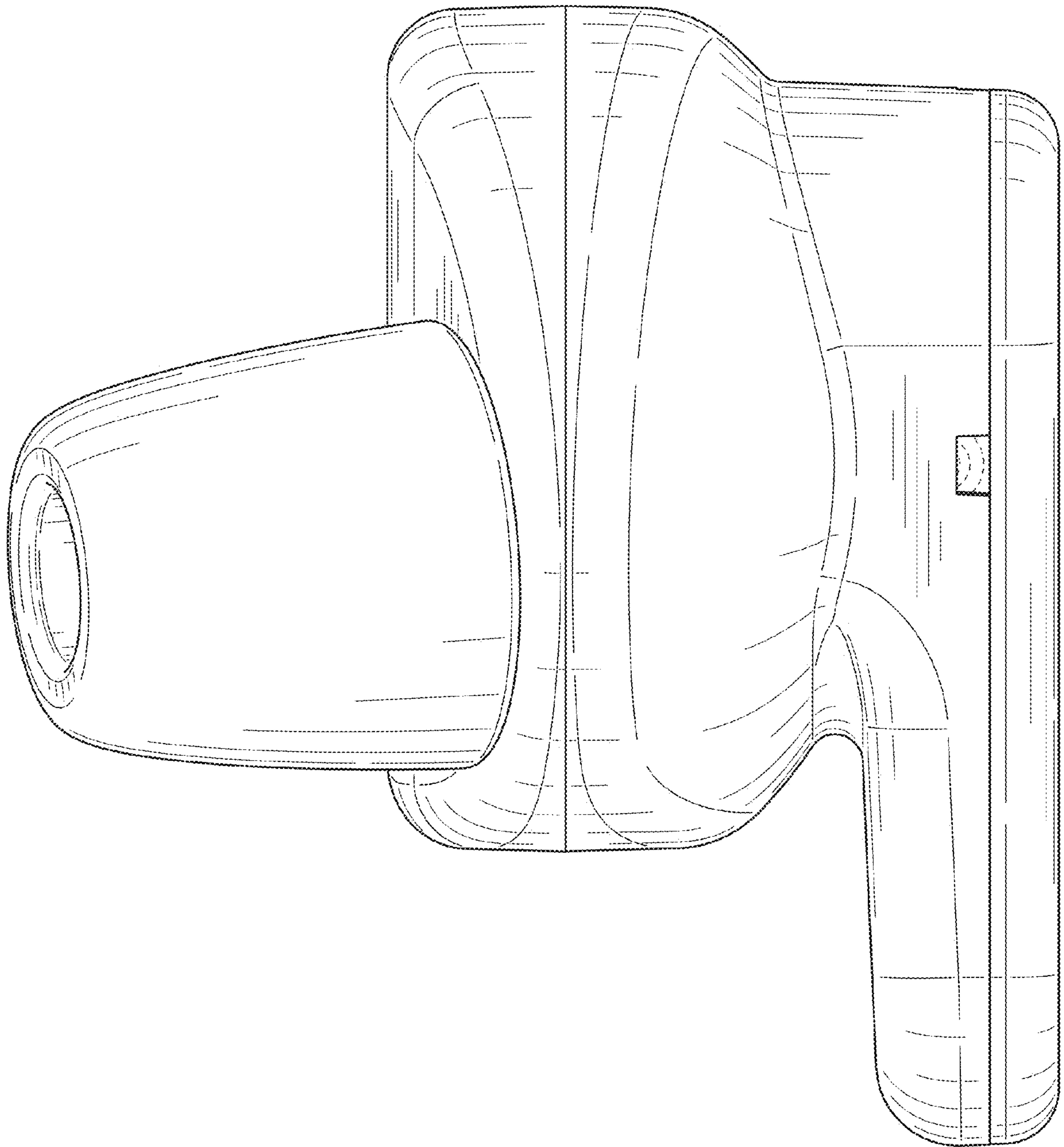


FIG. 4

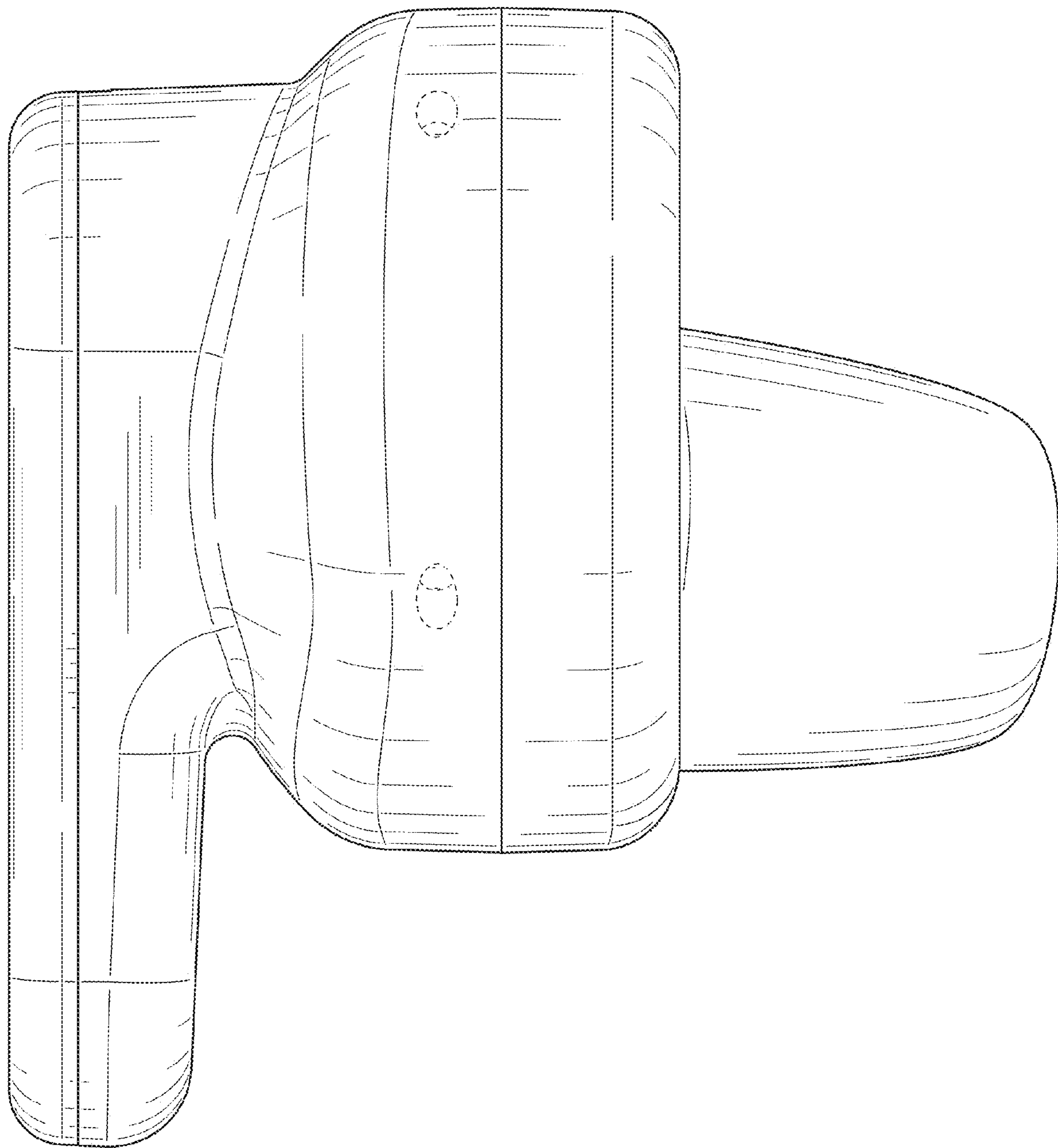


FIG. 5

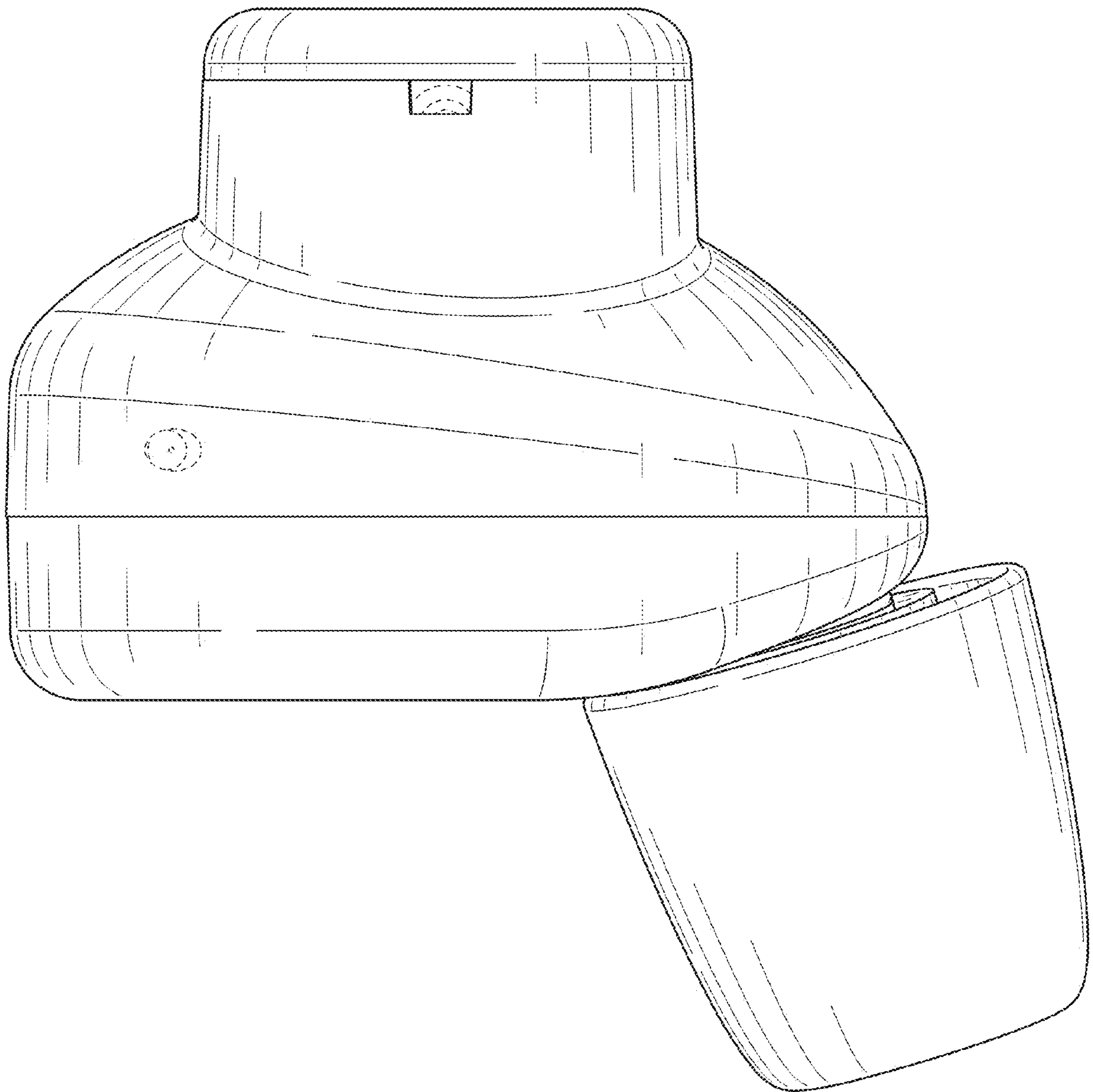


FIG. 6

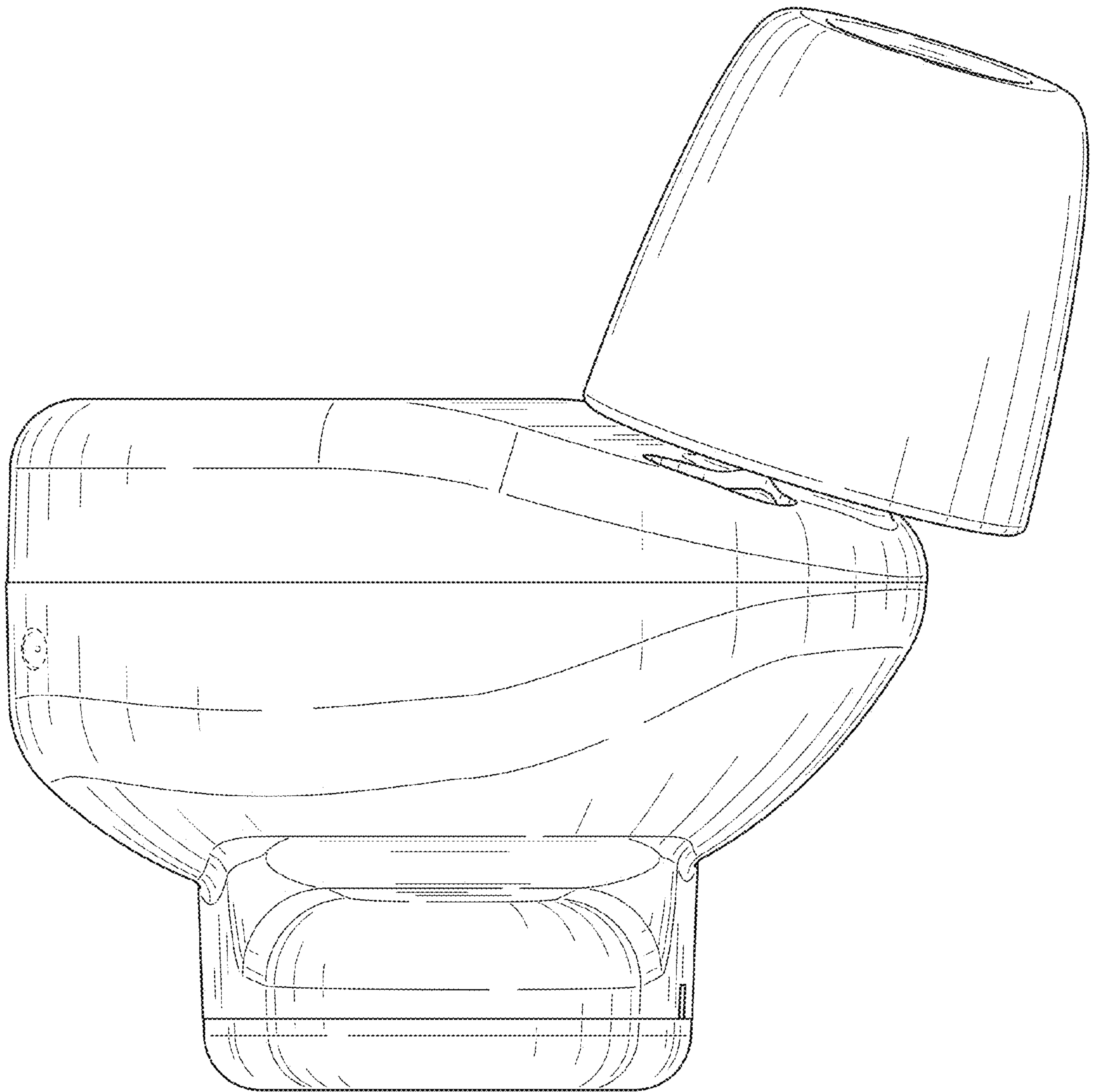


FIG. 7

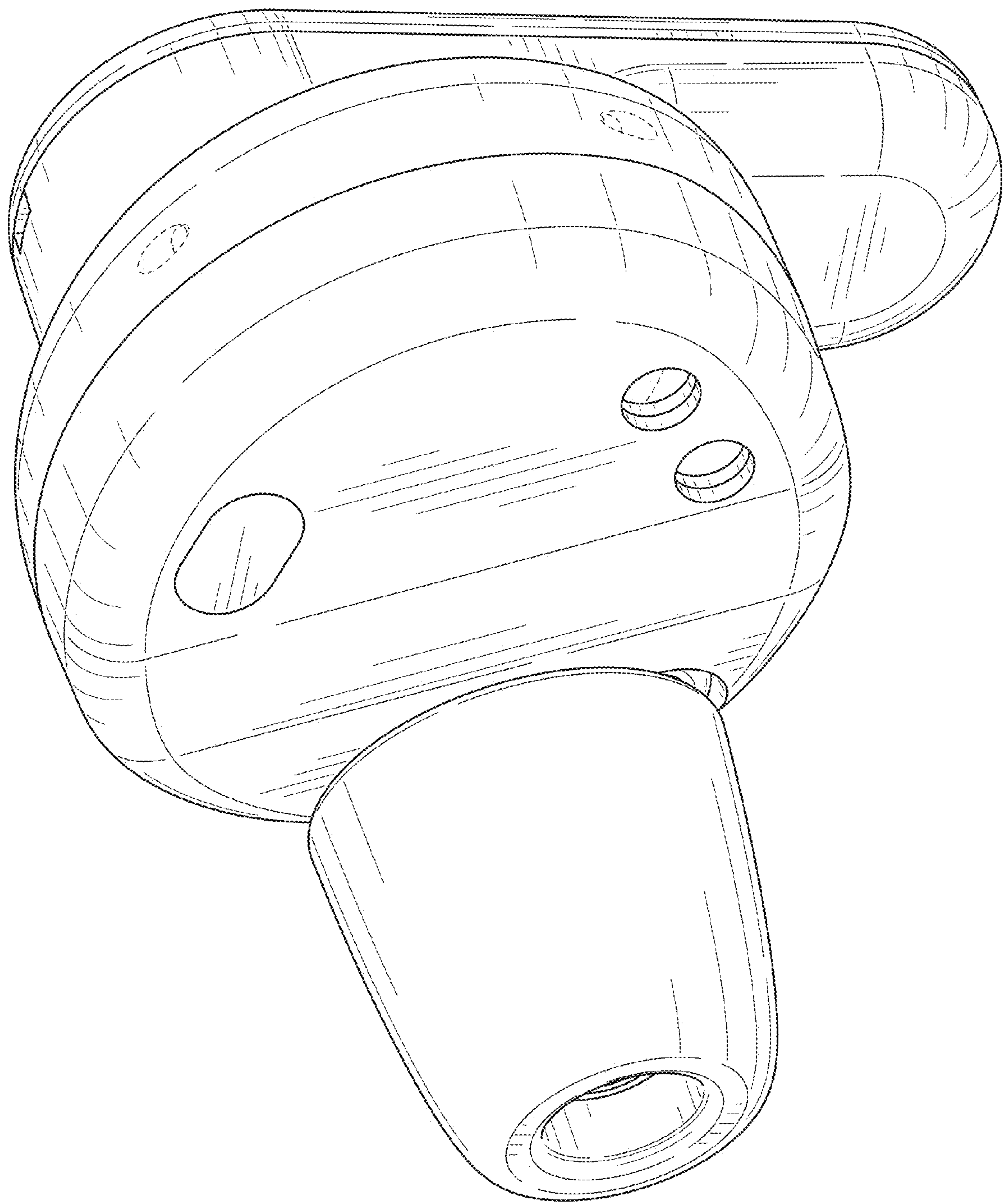


FIG. 8

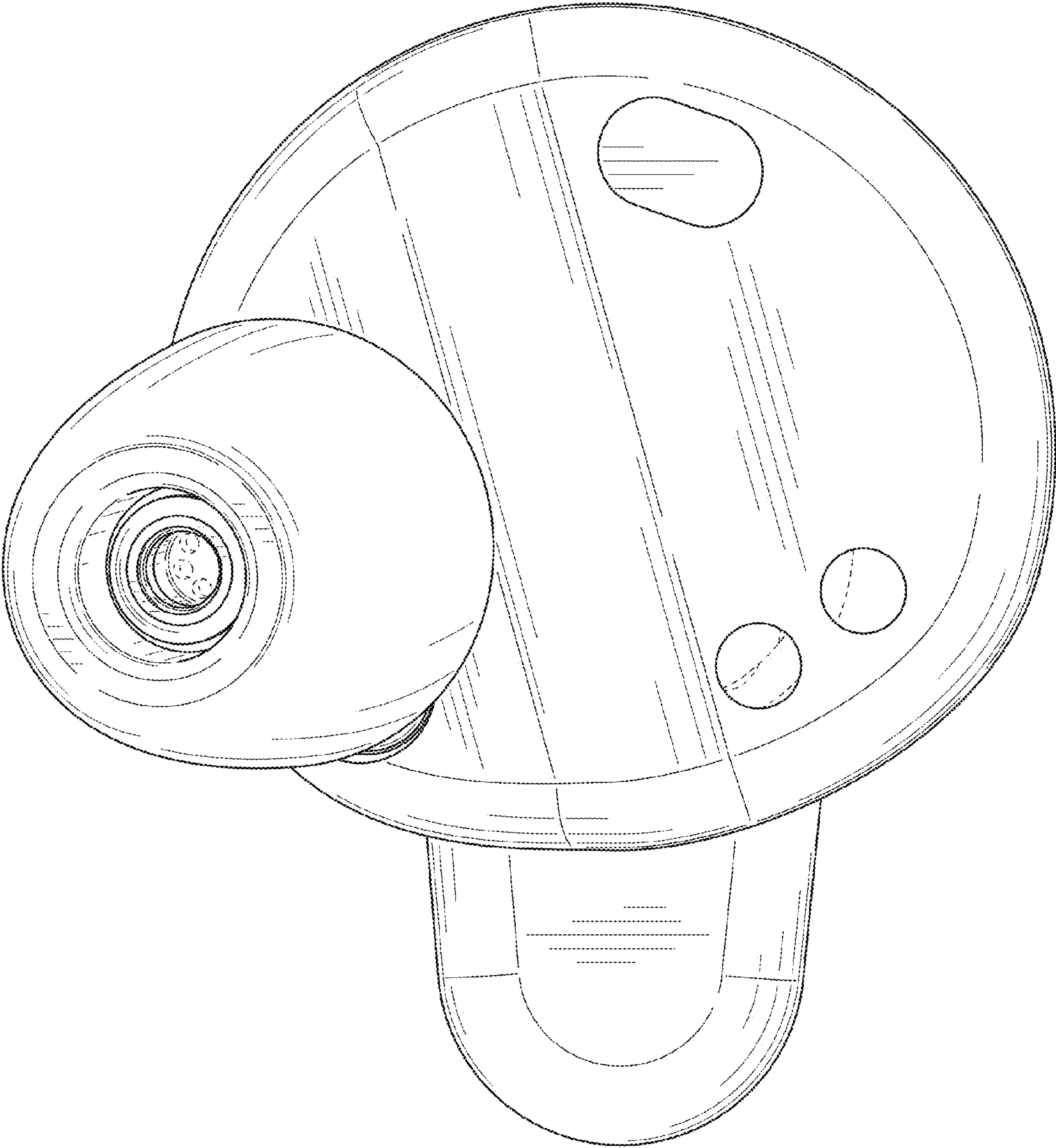


FIG. 9

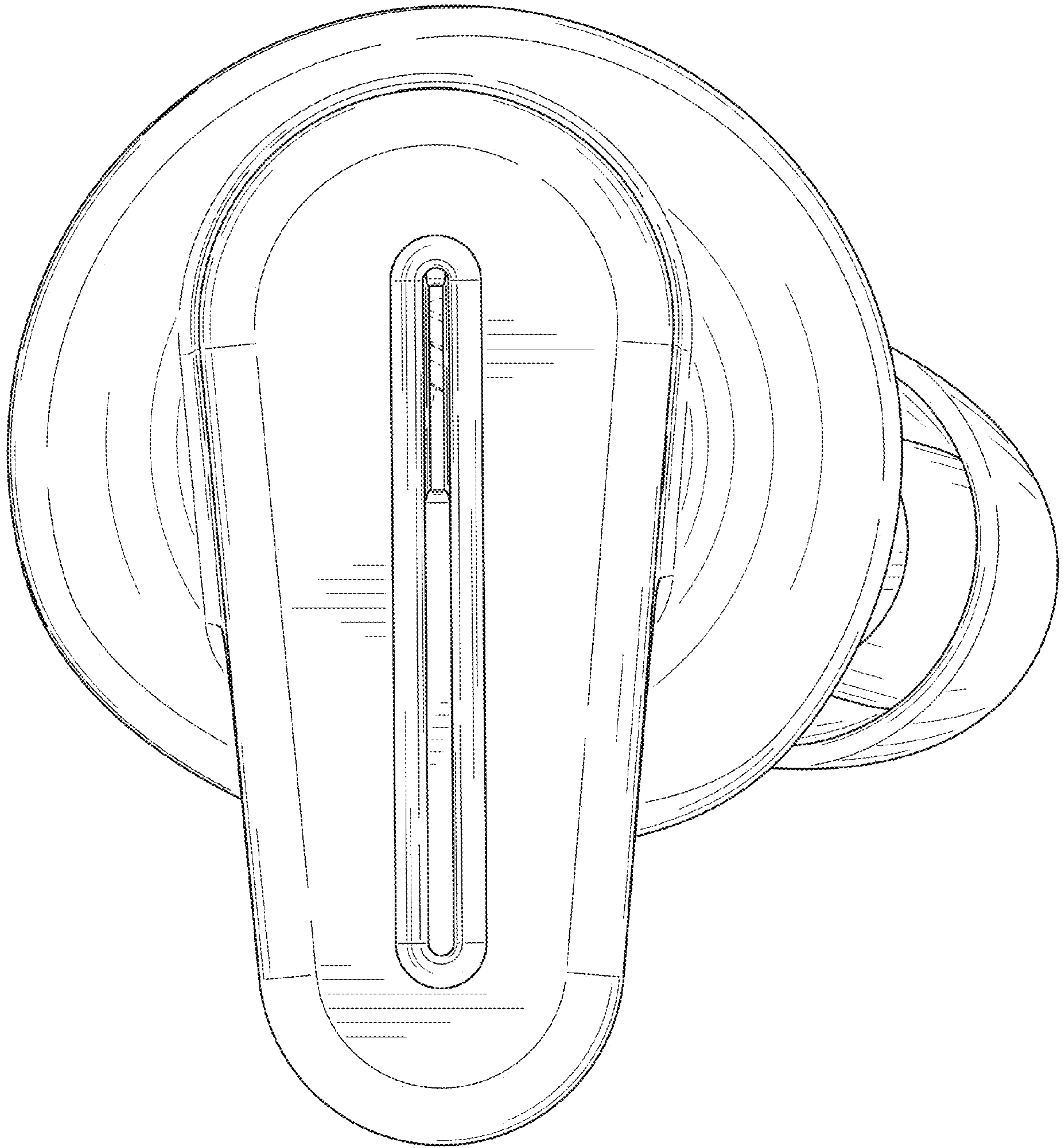


FIG. 10

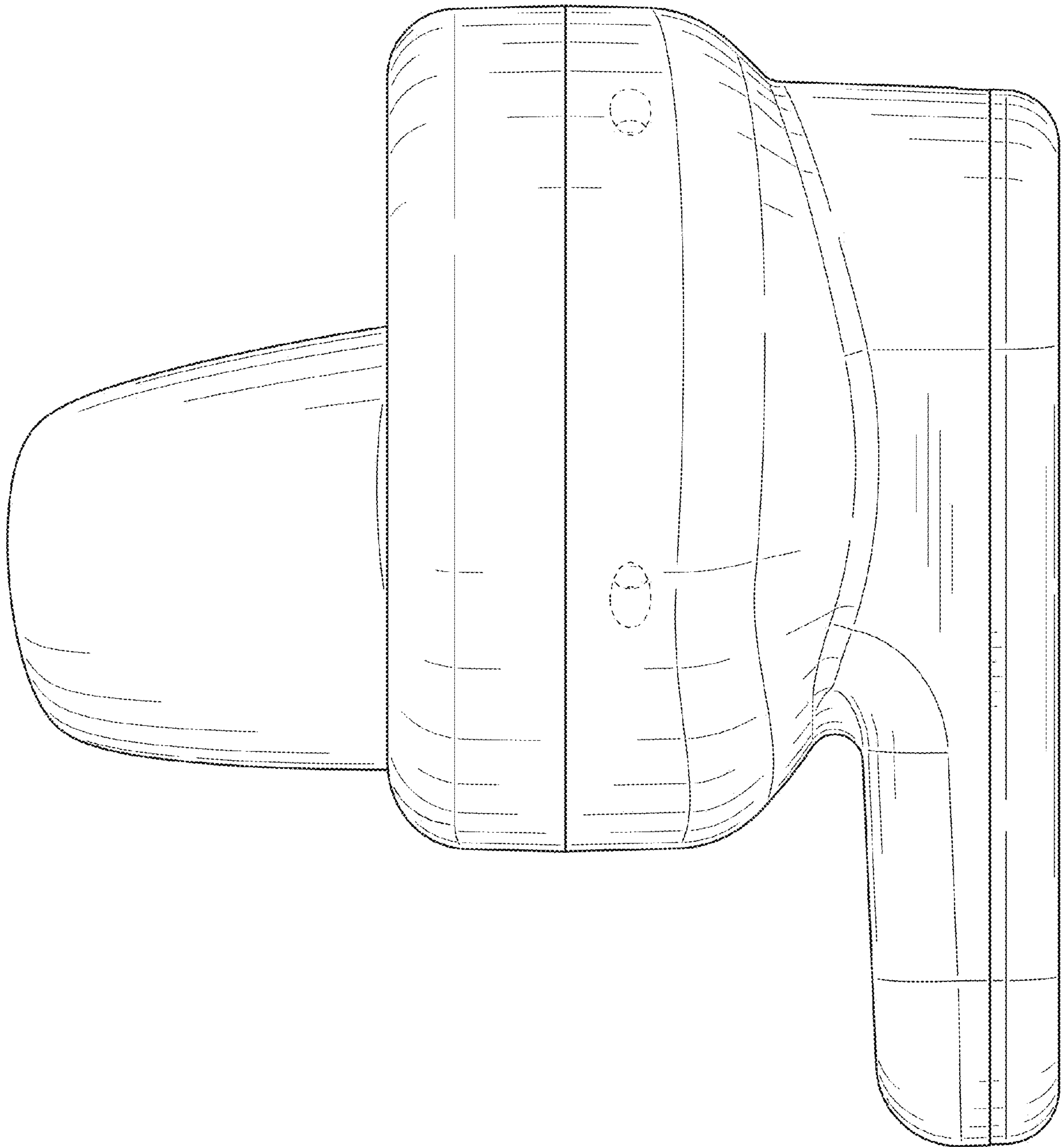


FIG. 11

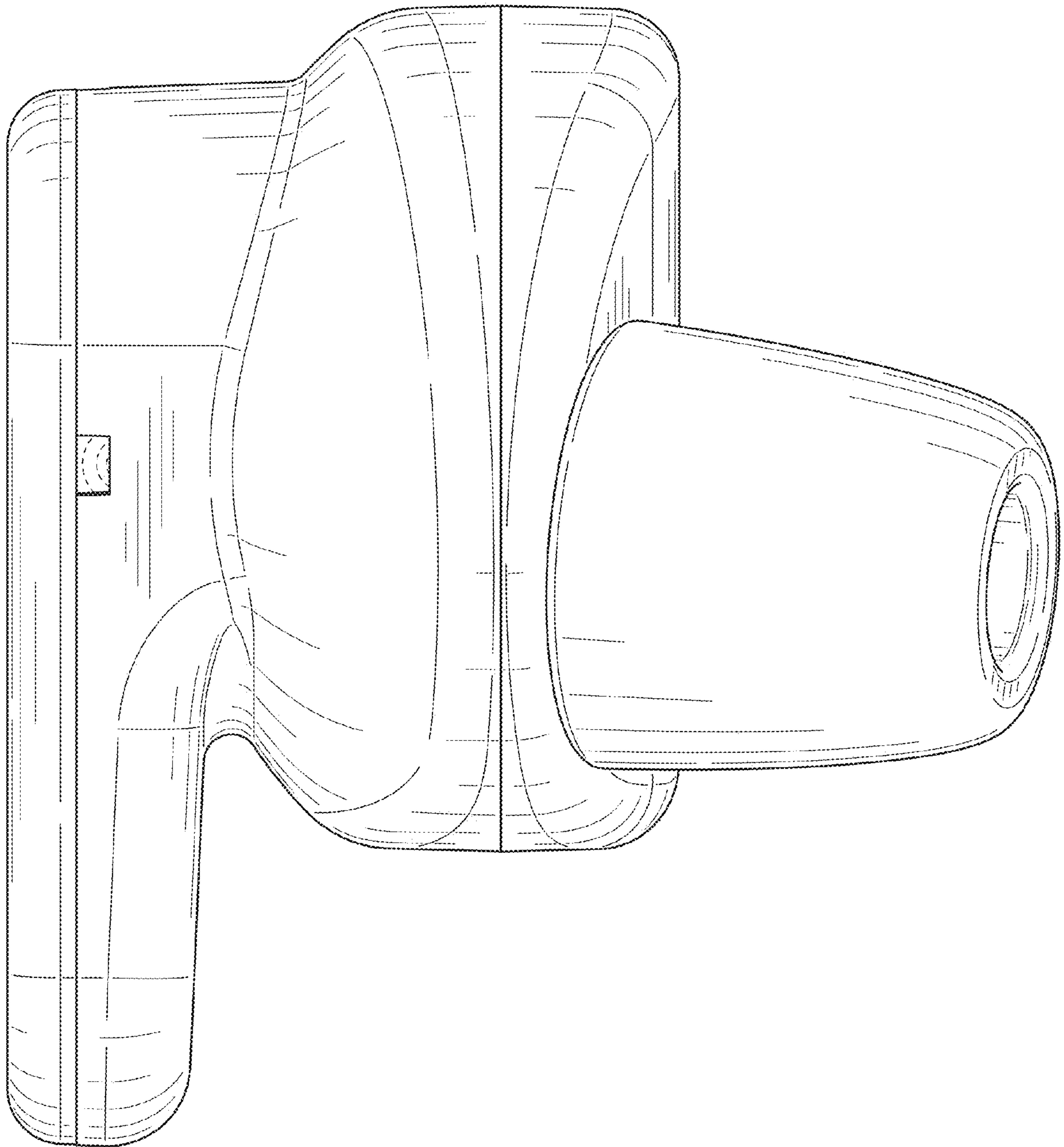


FIG. 12

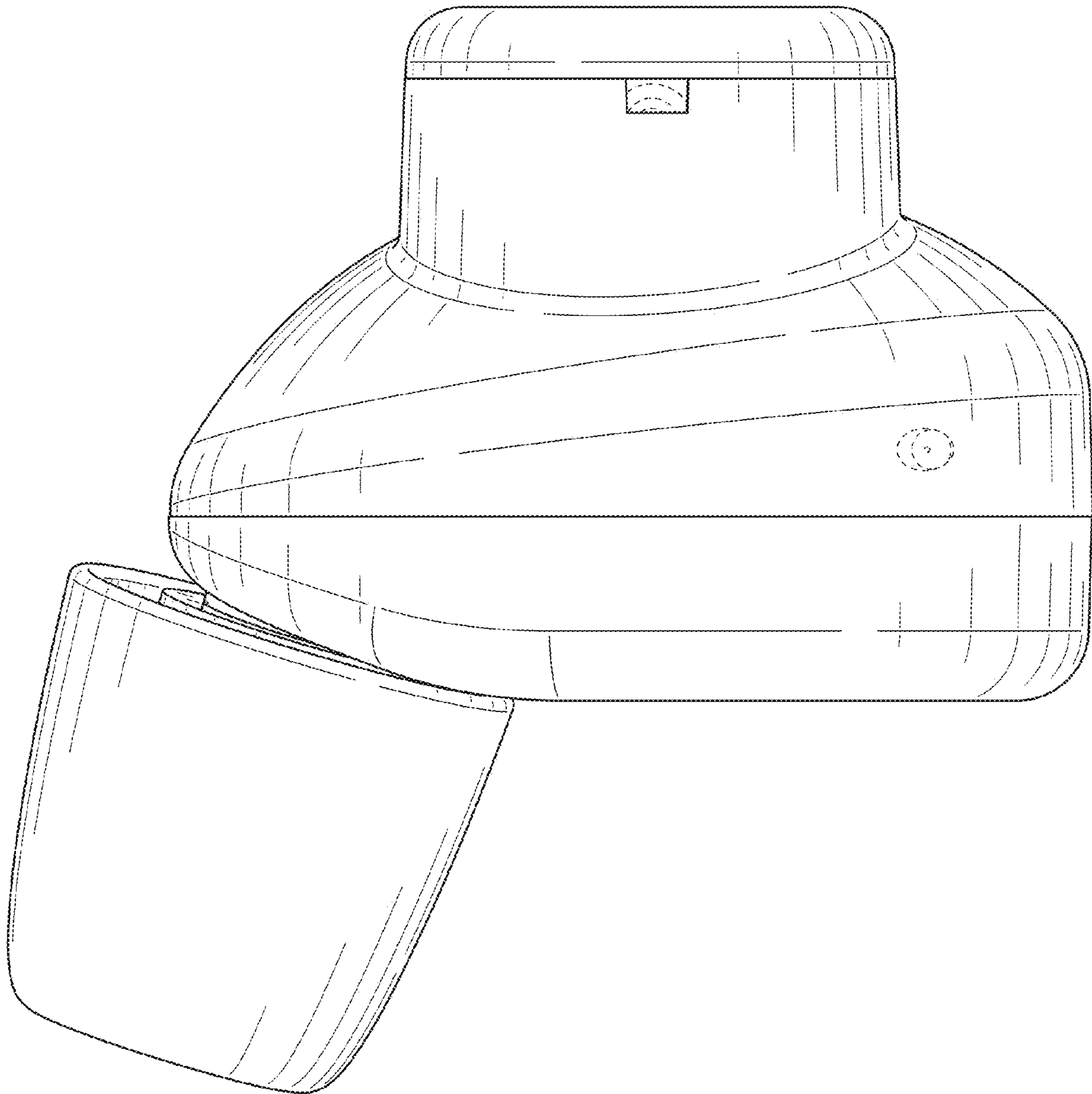


FIG. 13

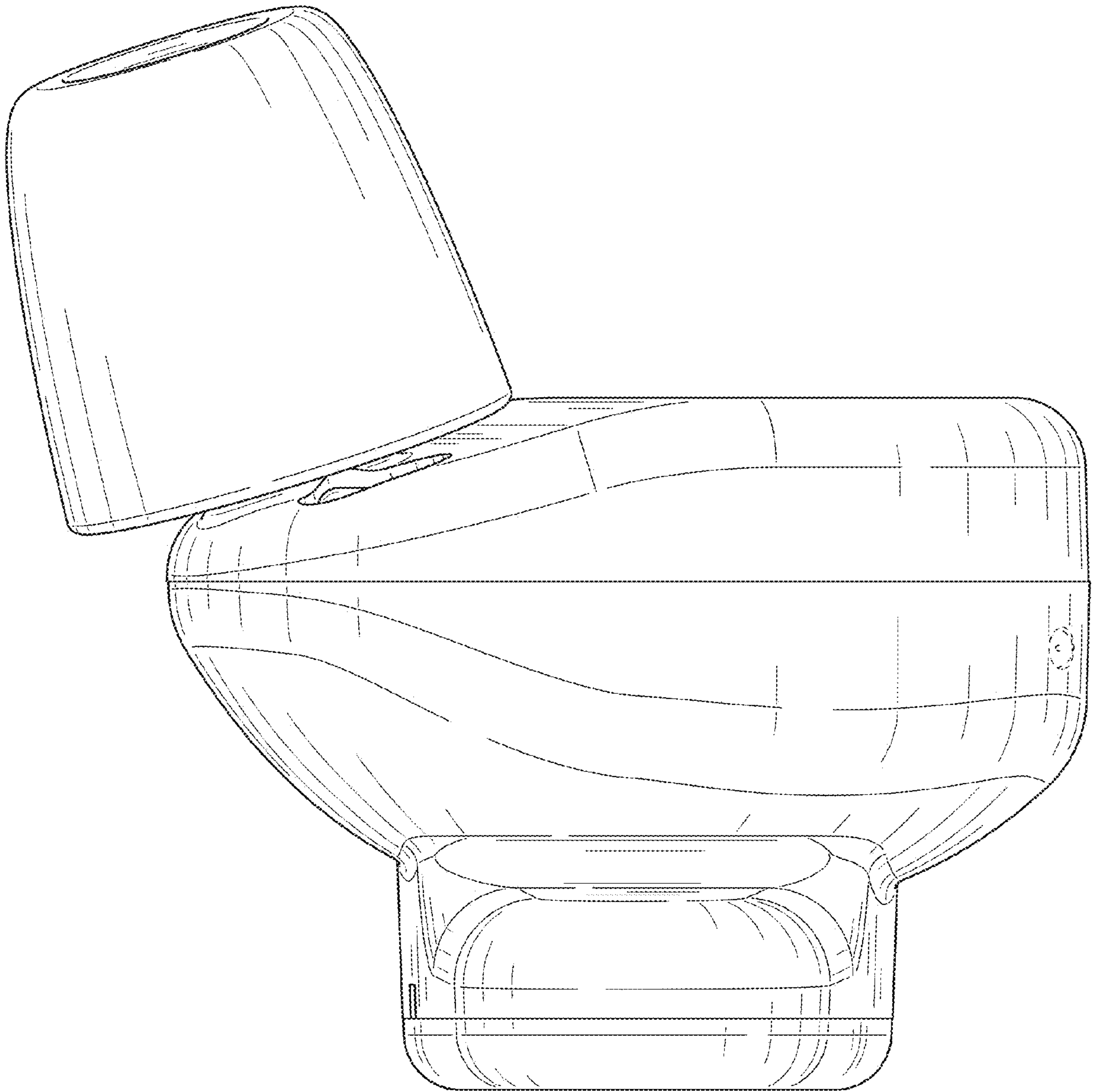


FIG. 14